KB354NT

Features

1.AC inputs.

- 2.High current transfer ratio.
- 2.Opaque type, mini-flat package.

3.Subminiature type (The volume is smaller than that of our conventional DIP

type by as far as 30%).

4. Isolation voltage between input and output Viso:3750Vrms.

5. Employs double transfer mold technology.

6.Recognized by UL and CUL, file NO.E225308.

7.Packge : 1000Pcs / Reel.

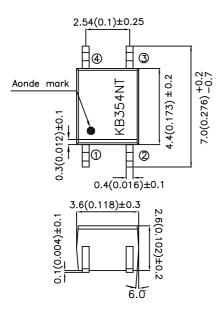
8.RoHS Compliant.

Applications

1. Hybrid substrates that require high density mounting.

2.Programmable controllers.

*PACKAGE DIMENSIONS (UNIT:mm) SMD Type



SO THE CONTROL OF THE

 $\begin{array}{l} \text{UNIT}: \text{MM[INCH]} \\ \text{TOLERANCE}: \pm 0.5 [\pm 0.02] \text{ UNLESS OTHERWISE NOTED.} \end{array}$

KB354NT

*Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit	
	Forward current	lF	±50	mA	
Input	Power dissipation	Р	70	mW	
Output	Collector-emitter voltage	Vceo	35	V	
	Emitter-collector voltage	Veco	6	V	
	Collector current	IC	50	mA	
	Collector power dissipation	Pc	150	mW	
Total power dissipation		P tot	170	mW	
^{*1} Isolation	voltage	V iso	3750	Vrms	
Operating temperature		T opr	-30 to +100	°C	
Storage temperature		T stg	-55 to +125	°C	
*2 Soldering temperature		T sol	260	°C	

*1 40 to 60% RH, AC for1 minute.

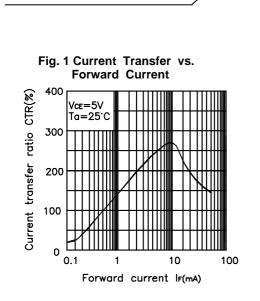
*2 For 10 seconds.

*Electro-optical Characteristics

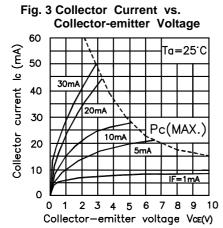
Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input	Forward voltage		VF	IF=± 20mA	-	1.2	1.4	V
	Peak forward voltage		Vfm	IFM=0.5A	-	-	3.0	V
Output	Collector dark current		ICEO	Vce=20V IF=0	-	-	10 ⁻⁷	А
	Collector-emitter breakdown voltage		BV _{CEO}	I _C =0.1mA IF=0	35	-	-	V
	Emitter-collector breakdown voltage		BV _{ECO}	I _E =10uA IF=0	6	-		V
Transfer charact- eristics	Current transfer ration		CTR	IF=± 1mA Vce=5V	20	-	400	%
	Collector-emitter saturation voltage		VCE (sat)	IF=± 20mA IC=1mA	-	0.1	0.2	V
	Response time Fall time	Rise time	tr	Vce=2V IC=2mA RL=100Ω	-	4	18	uS
		Fall time	tr			3	18	uS

Model No.	Rank mark	CTR(%)
KB354N1T	A	50 to 150
KB354NT	A or No mark	20 to 400

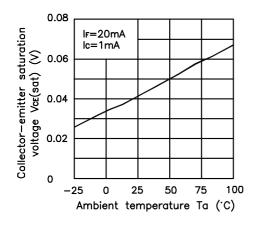
PHOTOCOUPLER



Kingbright







SPEC NO: DSAD2837 APPROVED: J. Lu

REV NO: V.8 CHECKED: Tracy Deng DATE: NOV/30/2005 DRAWN: F.LI PAGE: 3 OF 8 ERP:1205000038

Fig. 2 Forward Current vs. Forward voltage

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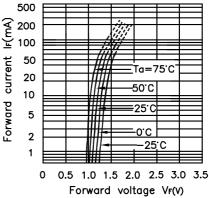


Fig. 4 Forward Current vs. Ambient Temperature

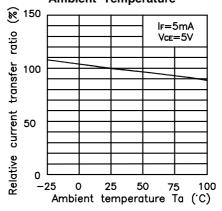
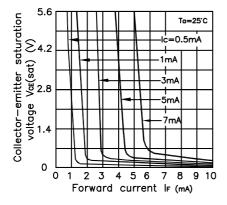


Fig. 6 Response Time vs.

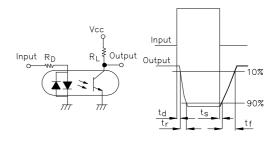
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Load Resistance 500 Vce=2V 200 lc=2mA Ta=25°C Response time (μ s) 100 50 20 10 5 td 2 1 тп 1 0.5 0.2 0.1 0.01 50 0.1 1 10 Load resistance $RL(K\Omega)$

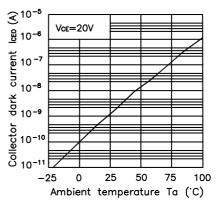
Fig. 7 Collector-emitter Saturation Voltage vs. Forward Current



Test Circuit for Response Time









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* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

(1) Dip soldering

Temperature	260°C or below (molten solder temperature)
Time	Less than 10 seconds.
Cycle	One cycle allowed to be dipped in solder including plastic nold portion.
Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(2) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2.Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen,

even if the voltage is within the absolute maximum ratings.

KB354NT

NOTES ON HANDLING

1.Recommended soldering conditions

- (1).Infrared reflow soldering
- · Peak reflow temperature

235 ° C or below(package surface temperature)

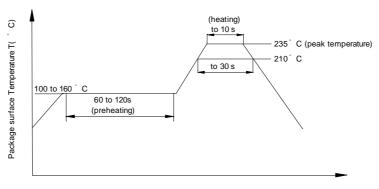
- Time of temperature higher than 210 $\degree\,$ C $\,$ $\,$ 30 seconds or less
- Number or reflows
- Flux

Rosin flux containing small amount of chlorine(The flux with a

maximum chlorine content of 0.2Wt % is recommended.)

Recommended Temperature Profile of infrared Reflow

Three



CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

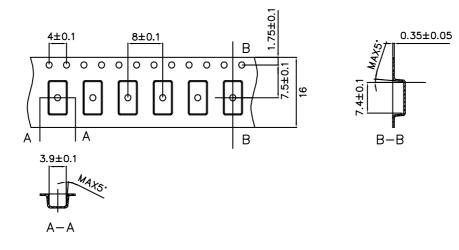
RESTRICTIONS ON PRODUCT USE

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices / types available in every country.
We are mention about our product quality stablity, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing KINGBRIGHT products, to observe standards of safety, and to a avoid situations in which a malfunction or failure of a KINGBRIGHT product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that KINGBRIGHT products are used within specified operating ranges as set forth in the most recent products specifications.

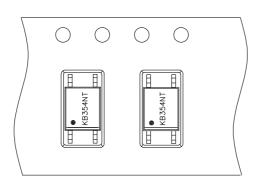
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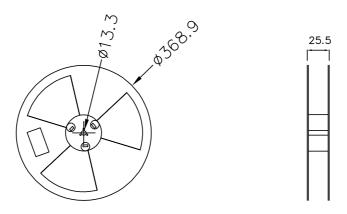
Outline and Dimension(Tape) (Units : mm)



Tape Direction

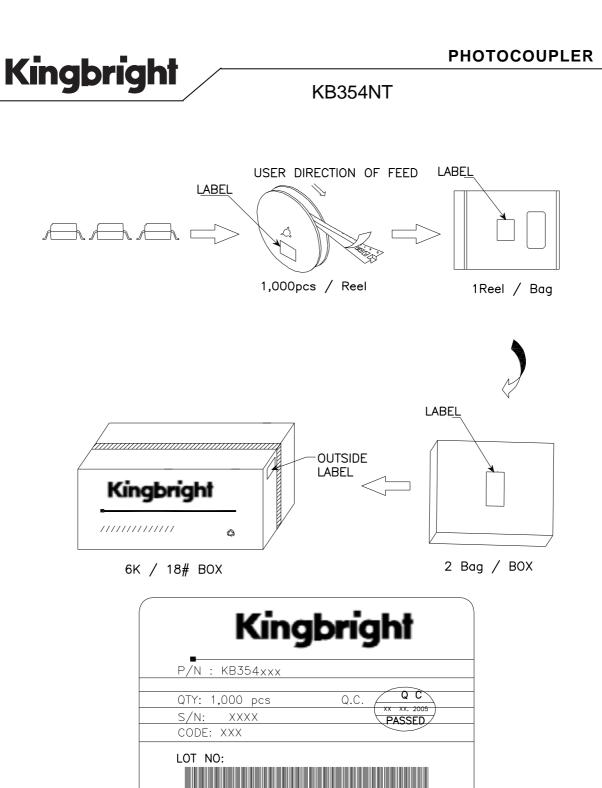


Outline and Dimension(Reel)



Packing:1000pcs/reel

SPEC NO: DSAD2837 APPROVED: J. Lu



MADE IN CHINA RoHS Compliant